XP132A11A1SR

Power MOSFET

■GENERAL DESCRIPTION

The XP132A11A1SR is a P-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. The small SOP-8 package makes high density mounting possible.

■ APPLICATIONS

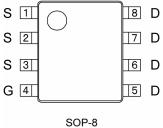
Notebook PCs

- •Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

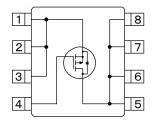
Low On-State Resistance : $Rds(on)=0.065 \Omega (Vgs=-10V)$: $Rds(on)=0.11 \Omega (Vgs=-4.5V)$ Ultra High-Speed Switching Driving Voltage : -4.5V P-Channel Power MOSFET DMOS Structure Package : SOP-8

■ PIN CONFIGURATION



(TOP VIEW)

■EQUIVALENT CIRCUIT



P-channel MOSFET (1 device built-in)

■PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1~3	S	Source
4	G	Gate
5~8	D	Drain

■ABSOLUTE MAXIMUM RATINGS

	Ta = 25						
PARAMETER	SYMBOL	RATINGS	UNITS				
Drain-Source Voltage	Vdss	-30	V				
Gate-Source Voltage	Vgss	±20	V				
Drain Current (DC)	ld	-5	А				
Drain Current (Pulse)	ldp	-20	А				
Reverse Drain Current	ldr	-5	А				
Channel Power Dissipation *	Pd	2.5	W				
Channel Temperature	Tch	150	°C				
Storage Temperature Range	Tstg	-55~150	°C				

* When implemented on a glass epoxy PCB

■ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics Ta = 25°C						
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=-30V, Vgs=0V	-	-	-10	μA
Gate-Source Leak Current	lgss	Vgs=±20V, Vds=0V	-	-	±1	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id=-1mA, Vds=-10V	-1.0	-	-2.5	V
Drain-Source On-State Resistance *	Rds(on)	Id=-3A, Vgs=-10V	-	0.055	0.065	Ω
		Id=-3A, Vgs=-4.5V	-	0.095	0.11	Ω
Forward Transfer Admittance *	Yfs	Id=-3A, Vds=-10V	-	6	-	S
Body Drain Diode Forward Voltage	Vf	lf=-5A, Vgs=0V	-	-0.85	-1.1	V

* Effective during pulse test.

Dynamic Characteristics

Dynamic CharacteristicsTa = 25°						
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds=-10V, Vgs=0V f=1MHz	-	680	-	pF
Output Capacitance	Coss		-	450	-	pF
Feedback Capacitance	Crss		-	170	-	pF

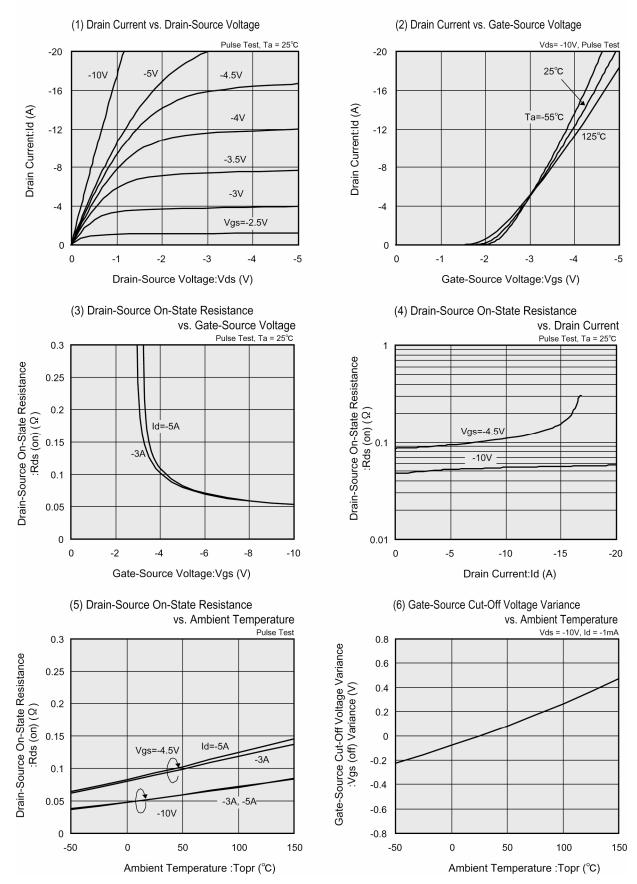
Switching Characteristics

Switching Characteristics Ta = 25°C						
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=-5V, Id=-3A Vdd=-10V	-	15	-	ns
Rise Time	tr		-	20	-	ns
Turn-Off Delay Time	td (off)		-	30	-	ns
Fall Time	tf		-	20	-	ns

Thermal Characteristics

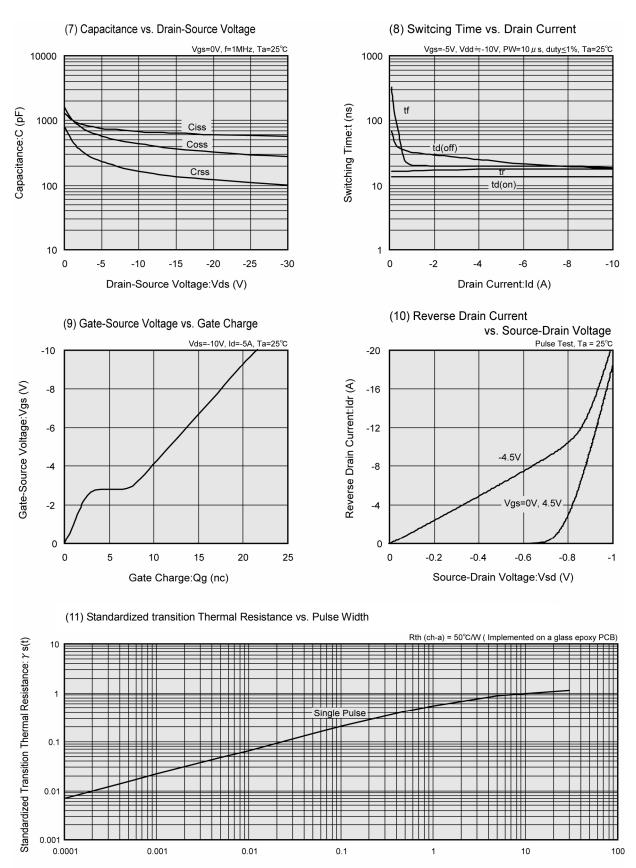
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	50	-	°C/W

TYPICAL PERFORMANCE CHARACTERISTICS



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■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



Pulse Width: PW (sec)

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